

# **HAT2139H**

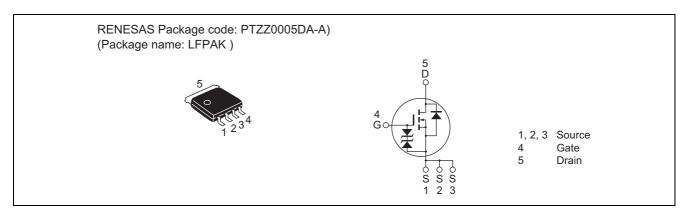
# Silicon N Channel Power MOS FET Power Switching

REJ03G0055-0500 Rev.5.00 Sep 20, 2005

### **Features**

- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance  $R_{DS(on)} = 9 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$

### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	40	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	20	A
Drain peak current	I <sub>D(pulse)</sub> Note1	80	A
Body-drain diode reverse drain current	I <sub>DR</sub>	20	А
Avalanche current	I <sub>AP</sub> Note 3	10	A
Avalanche energy	E <sub>AR</sub> Note 3	8	mJ
Channel dissipation	Pch Note2	15	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Tc = 25°C

3. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

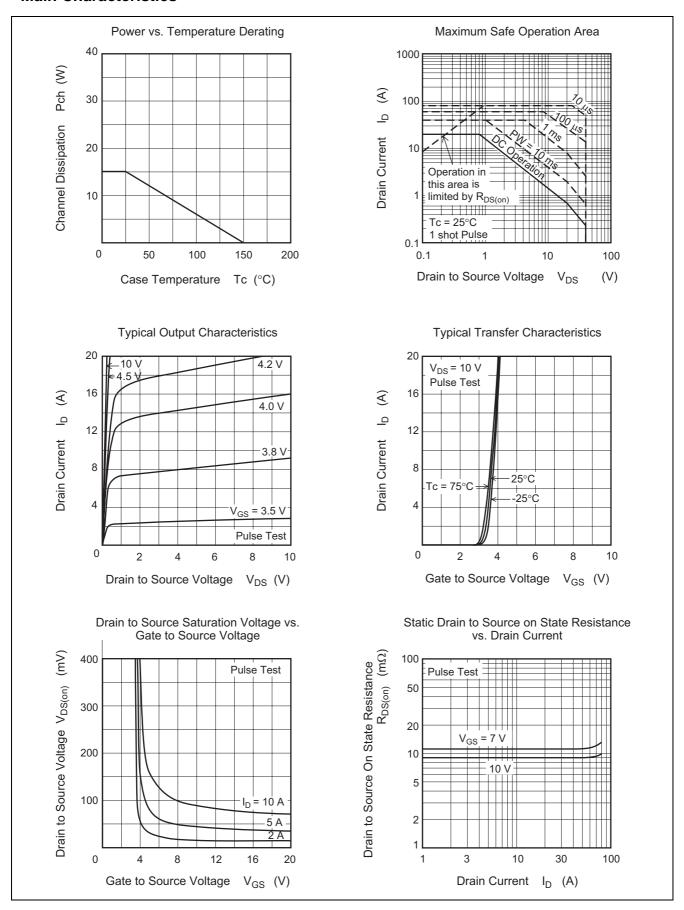
# **Electrical Characteristics**

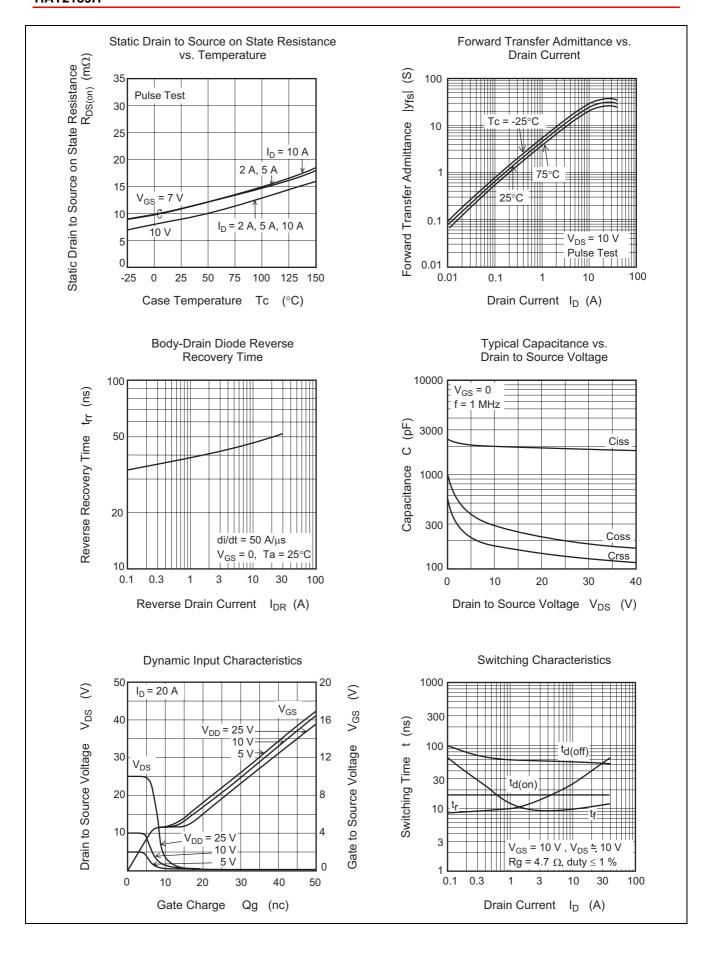
 $(Ta = 25^{\circ}C)$ 

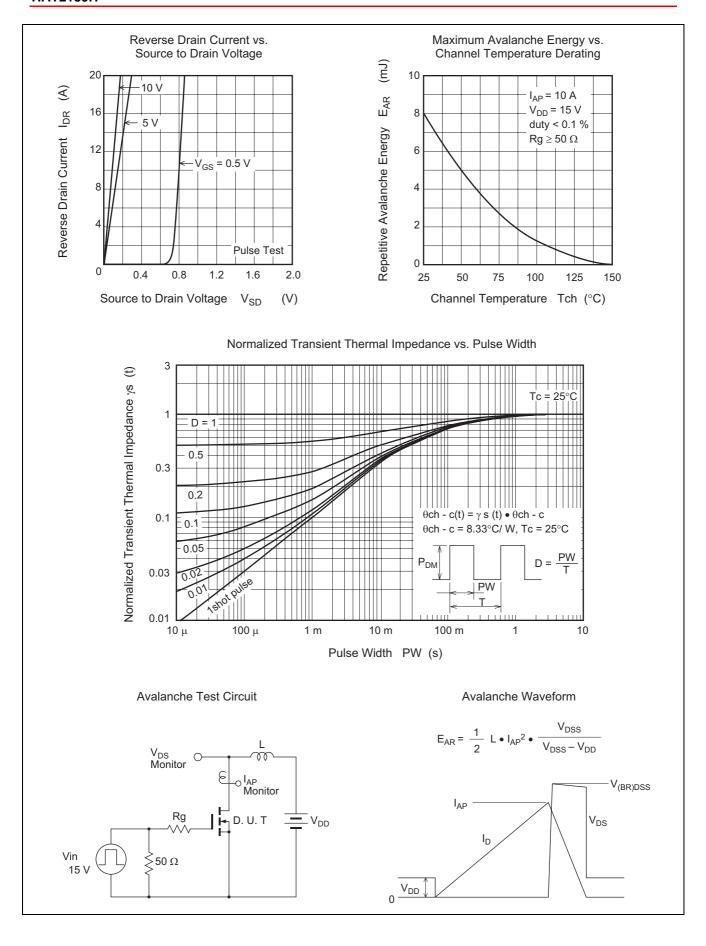
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	$V_{(BR)DSS}$	40			V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to source leak current	I <sub>GSS</sub>	_	_	± 10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 40 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	3.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	
Static drain to source on state	R <sub>DS(on)</sub>	_	9.0	11.5	mΩ	$I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R <sub>DS(on)</sub>	_	11.0	15.0	mΩ	$I_D = 10 \text{ A}, V_{GS} = 7 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y <sub>fs</sub>	15	25	_	S	$I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	2000	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	
Output capacitance	Coss	_	290	_	pF		
Reverse transfer capacitance	Crss	_	175	_	pF		
Total gate charge	Qg	_	30	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	
Gate to source charge	Qgs	_	8	_	nC		
Gate to drain charge	Qgd	_	5	_	nC		
Turn-on delay time	t <sub>d(on)</sub>	_	17	_	ns	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A},$	
Rise time	t <sub>r</sub>	_	23	_	ns	$V_{DD} \cong 10 \text{ V}, R_L = 1.0 \Omega,$	
Turn-off delay time	t <sub>d(off)</sub>	_	58	_	ns	$Rg = 4.7 \Omega$	
Fall time	t <sub>f</sub>	_	10	_	ns		
Body-drain diode forward voltage	$V_{DF}$	_	0.83	1.08	V	IF = 20 A, V <sub>GS</sub> = 0 Note4	
Body-drain diode reverse recovery	t <sub>rr</sub>	_	50	_	ns	IF = 20 A, V <sub>GS</sub> = 0	
time						$di_F/dt = 50 A/ \mu s$	

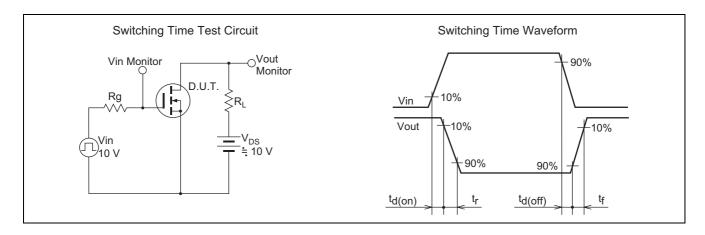
Notes: 4. Pulse test

## **Main Characteristics**

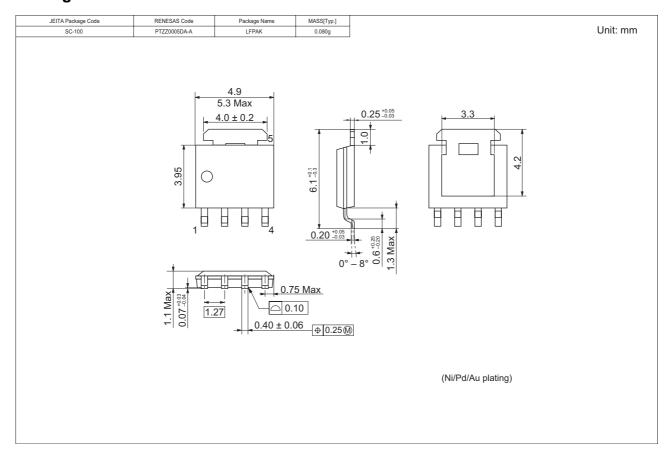








# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2139H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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